



附表 3-2:

批准证书附件

Lab: Testing Center of the 58th Research Institute of China Electronics Technology Corporation
 Add: No. 5, HuiHe Road, Binhu District, Wuxi, Jiangsu Province, China, Building No. 301&102

No	Products, Materials	Items, Parameter		Title, Code of specification, standard or method used	Restriction or limitation	measuring capacity	Note
		No	Items, Parameter				
1	Integrated Circuits (MCU, Memory, Controller)	1	Input Clamping Voltage V_{IK}	Semiconductor Devices Integrated Circuits Part2: Digital Integrated Circuits GB/T 17574-1998 Article 6, Section 2, Part IV	Current Range: -200mA ~ +200mA;	Voltage Measure Range: -24V ~ +24V;	
		2	Output High Level Voltage V_{OH}	Semiconductor Devices Integrated Circuits Part2: Digital Integrated Circuits GB/T 17574-1998 Article 1, Section 2, Part IV	Current Range: -200mA ~ +0mA;	Voltage Measure Range: -1V ~ +6V	
		3	Output Low Level Voltage V_{OL}	Semiconductor Devices Integrated Circuits Part2: Digital Integrated Circuits GB/T 17574-1998 Article 1, Section 2, Part IV	Current Range: -0mA ~ +200mA;	Voltage Measure Range: -1V ~ +6V	
		4	Input High Level Current I_{IH}	Semiconductor Devices Integrated Circuits Part2: Digital Integrated Circuits GB/T 17574-1998 Article 2, Section 2, Part IV	Voltage Range: -24V ~ +24V	Current Measure Range: -200mA ~ +200mA;	
		5	Input Low Level Current I_{IL}	Semiconductor Devices Integrated Circuits Part2: Digital Integrated Circuits GB/T 17574-1998 Article 2, Section 2, Part IV	Voltage Range: -24V ~ +24V	Current Measure Range: -200mA ~ +200mA;	
		6	Power Supply Current I_{CC}	Semiconductor Devices Integrated Circuits Part2: Digital Integrated Circuits GB/T 17574-1998 Article 1, Section 3, Part IV	Voltage Range: -30V ~ +30V	Current Measure Range: -0A ~ +15A Current Measure Range: -200mA ~ +200mA;	
		7	Output Low Level Power Supply Current I_{CCL}	Semiconductor Devices Integrated Circuits Part2: Digital Integrated Circuits GB/T 17574-1998 Article 4, Section 2, Part IV	Voltage Range: -30V ~ +30V	Current Measure Range: -0A ~ +15A Current Measure Range: -200mA ~ +200mA;	

		8	Output High Level Power Supply Current I_{CCH}	Semiconductor Devices Integrated Circuits Part2: Digital Integrated Circuits GB/T 17574-1998 Article 4, Section 2, Part IV	Voltage Range: -30V～+30V	Current Measure Range: -0A～+15A Current Measure Range: -200mA～+200mA;	
		9	Output transmission delay time from low level to high level t_{PLH}	Semiconductor Devices Integrated Circuits Part2: Digital Integrated Circuits GB/T 17574-1998 Article 4.1.2, Section 3, Part IV	Frequency Range: 0～800Mhz Voltage Range: -0V～+7.0V	Current Measure Range: ≥30ps	
		10	Output transmission delay time from high level to low level t_{PHL}	Semiconductor Devices Integrated Circuits Part2: Digital Integrated Circuits GB/T 17574-1998 Article 4.1.2, Section 3, Part IV	Frequency Range: 0～800Mhz Voltage Range: -0V～+7.0V	Current Measure Range: ≥30ps	
		11	Output transmission delay time from high resistance state to high level t_{PZH}	Semiconductor Devices Integrated Circuits Part2: Digital Integrated Circuits GB/T 17574-1998 Article 4.5, Section 3, Part IV	Frequency Range: 0～800Mhz Voltage Range: -0V～+7.0V	Current Measure Range: ≥30ps	
		12	Output transmission delay time from high resistance state to low level t_{PZL}	Semiconductor Devices Integrated Circuits Part2: Digital Integrated Circuits GB/T 17574-1998 Article 4.5, Section 3, Part IV	Frequency Range: 0～800Mhz Voltage Range: -0V～+7.0V	Current Measure Range: ≥30ps	
		13	Output transmission delay time from high level to high resistance state t_{PHZ}	Semiconductor Devices Integrated Circuits Part2: Digital Integrated Circuits GB/T 17574-1998 Article 4.5, Section 3, Part IV	Frequency Range: 0～800Mhz Voltage Range: -0V～+7.0V	Current Measure Range: ≥30ps	
		14	Output transmission delay time from low level to high resistance state t_{PLZ}	Semiconductor Devices Integrated Circuits Part2: Digital Integrated Circuits GB/T 17574-1998 Article 4.5, Section 3, Part IV	Frequency Range: 0～800Mhz Voltage Range: -0V～+7.0V	Current Measure Range: ≥30ps	
2	Integrated Circuits (Voltage comparator)	1	Input Offset Voltage V_{IO}	Basic Principle of Voltage Comparator Test Method SJ/T 10805-2018 Section 5.1	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Voltage Measure Range: -50V～+50V	

		2	Input Offset Current I_{IO}	Basic Principle of Voltage Comparator Test Method SJ/T 10805-2018 Section 5.3	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Current Measure Range: -50uA～+50uA;	
		3	Input Bias Current I_{IB}	Basic Principle of Voltage Comparator Test Method SJ/T 10805-2018 Section 5.5	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Current Measure Range: -50uA～+50uA;	
		4	Output High Level Voltage V_{OH}	Basic Principle of Voltage Comparator Test Method SJ/T 10805-2018 Section 5.13	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Voltage Measure Range: -50V～+50V	
		5	Output Low Level Voltage V_{OL}	Basic Principle of Voltage Comparator Test Method SJ/T 10805-2018 Section 5.14	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Voltage Measure Range: -50V～+50V	
3	Integrated Circuits (Operational Amplifier)	1	Input Offset Voltage V_{IO}	Test Methods for Operational Amplifiers of Semiconductor Integrated Circuits QJ 2491/1993 Section 5.1	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Voltage Measure Range: -50V～+50V	
		2	Input Offset Current I_{IO}	Test Methods for Operational Amplifiers of Semiconductor Integrated Circuits QJ 2491/1993 Section 5.4	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Current Measure Range: -50uA～+50uA;	
		3	Input Bias Current I_{IB}	Test Methods for Operational Amplifiers of Semiconductor Integrated Circuits QJ 2491/1993 Section 5.7	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Current Measure Range: -50uA～+50uA;	
		4	Open-loop gain A_{VD}	Test Methods for Operational Amplifiers of Semiconductor Integrated Circuits QJ 2491/1993 Section 5.10	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Voltage Measure Range: -50V～+50V	

		5	Commo Mode Rejection Ratio K _{CMR}	Test Methods for Operational Amplifiers of Semiconductor Integrated Circuits QJ 2491/1993 Section 5.11	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Voltage Measure Range: -50V～+50V	
		6	Output Voltage Conversion Rate SR	Test Methods for Operational Amplifiers of Semiconductor Integrated Circuits QJ 2491/1993 Section 5.21	Current Range: -2A～+2A; Voltage Range: -0V～+6.5V Frequency Range: 0～800Mhz	SR≤4000V/us	
		7	Gain Bandwidth G.BW	Test Methods for Operational Amplifiers of Semiconductor Integrated Circuits QJ 2491/1993 Section 5.32	Current Range: -2A～+2A; Voltage Range: -0V～+6.5V Frequency Range: 0～800Mhz	G.BW≤1000*800M hz	
4	Integrated Circuits (Voltage Regulator)	1	Output Votage V _o	Test Methods for Voltage Regulators of Semiconductor Integrated Circuits GB/T 4377-2018 Section 4.17	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Voltage Measure Range: -50V～+50V	
		2	Votage Regulation SV	Test Methods for Voltage Regulators of Semiconductor Integrated Circuits GB/T 4377-2018 Section 4.1	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Voltage Measure Range: -50V～+50V	
		3	Current Regulation ST	Test Methods for Voltage Regulators of Semiconductor Integrated Circuits GB/T 4377-2018 Section 4.2	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Voltage Measure Range: -50V～+50V	
5	Integrated Circuits (Analog Switch)	1	Analog Voltage Operating Range V _A	Test Methods for Analog Switch of Semiconductor Integrated Circuits GB/T 14028-2018 Section 2.1	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Voltage Measure Range: -50V～+50V	

		2	On-resistance Ron	Test Methods for Analog Switch of Semiconductor Integrated Circuits GB/T 14028-2018 Section 2.2	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Resistance Measure Range: 1Ω~999KΩ	
		3	Cut-off State Drain Current ID(OFF)	Test Methods for Analog Switch of Semiconductor Integrated Circuits GB/T 14028-2018 Section 2.4	Current Range: -2A～+2A; Voltage Range: -50V～+50V	Current Measure Range: -2A～+2A;	
6	Discrete Semiconductor Devices -Diodes (Voltage regulation diodes, switching diodes, current regulation diodes, transient suppression diodes)	1	Forward Voltage V _F	Discrete Semiconductor Devices Part3: Signal (including switch) and Adjustment Diodes GB/T 6571-1995 Article 2, Section 1, Part IV	Current Range: 0~200A	Voltage Measure Range: 0~2KV	
		2	Reverse Current I _R	Discrete Semiconductor Devices Part3: Signal (including switch) and Adjustment Diodes GB/T 6571-1995 Article 1, Section 1, Part IV	Voltage Range: 0~2KV	Current Measure Range: 0A~10A	
		3	Operating Voltage V _Z	Discrete Semiconductor Devices Part3: Signal (including switch) and Adjustment Diodes GB/T 6571-1995 Article 1, Section 2, Part IV	Current Range: 0~10A	Voltage Measure Range: 0~2KV	
		4	Differential Resistance r _Z	Discrete Semiconductor Devices Part3: Signal (including switch) and Adjustment Diodes GB/T 6571-1995 Article 2, Section 2, Part IV	Current Range: 0~10A Voltage Range: 0~1KV	Resistance Measure Range: 1mΩ~999KΩ	
		5	Breakdown Voltage V _(BR)	Semiconductor Devices Discrete Devices and Integrated Circuits Part2: Rectifiers GB/T 4023-2015 Article 7.1.3	Current Range: 0~10mA	Voltage Measure Range: 0~2KV	
7	Discrete Semiconductor Devices -Bipolar transistor	1	Collector-base cut-off Current I _{CBO}	Semiconductor Devices Discrete Devices and Integrated Circuits Part7: Bipolar transistor GB/T4587-1994 Article 2.1, Section 1, Part IV	Voltage Range: 0~2KV	Current Measure Range: 0A~10A	
		2	Emitter-base cut-off current I _{EBO}	Semiconductor Devices Discrete Devices and Integrated Circuits Part7: Bipolar transistor GB/T4587-1994 Article 2.2, Section 1, Part IV	Voltage Range: 0~2KV	Current Measure Range: 0A~10A	

		3	Collector-emitter cut-off current I_{CEO}	Semiconductor Devices Discrete Devices and Integrated Circuits Part7: Bipolar transisitor GB/T4587-1994 Article 3, Section 1, Part IV	Voltage Range: 0~2KV	Current Measure Range: 0A~10A	
		4	Collector-emitter saturation voltage V_{CEsat}	Semiconductor Devices Discrete Devices and Integrated Circuits Part7: Bipolar transisitor GB/T4587-1994 Article 4, Section 1, Part IV	Current Range: 0~200A	Voltage Measure Range: 0V~2KV	
		5	Base-emitter saturation voltage V_{BEsat}	Semiconductor Devices Discrete Devices and Integrated Circuits Part7: Bipolar transisitor GB/T4587-1994 Article 5, Section 1, Part IV	Current Range: 0~200A	Voltage Measure Range: 0V~2KV	
		6	Common emitter forword current transmission hfe	Semiconductor Devices Discrete Devices and Integrated Circuits Part7: Bipolar transisitor GB/T4587-1994 Article 9.6, Section 1, Part IV	Current Range: 0~40A Voltage Range: 0~30V	Measure Range: 0~9999	
		7	Collector-base breakdown voltage $V_{(BR)CBO}$	Semiconductor Devices Discrete Devices and Integrated Circuits Part7: Bipolar transisitor GB/T4587-1994 Article 10.2, Section 1, Part IV	Current Range: 0~10mA	Voltage Measure Range: 0V~2KV	
		8	Emitter-base breakdown voltage $V_{(BR)EBO}$	Semiconductor Devices Discrete Devices and Integrated Circuits Part7: Bipolar transisitor GB/T4587-1994 Article 10.2, Section 1, Part IV	Current Range: 0~10mA	Voltage Measure Range: 0V~2KV	
		1	Gate cut-off current I_{GSS}	Semiconductor Devices Discrete Devices and Integrated Circuits Part8: Field effect transisitor GB/T 4586-1994 Article 2, Part IV	Voltage Range: 0~2KV	Current Measure Range: 0A~10A	
		2	Drain cut-off current I_{DSS}	Semiconductor Devices Discrete Devices and Integrated Circuits Part8: Field effect transisitor GB/T 4586-1994 Article 4, Part IV	Voltage Range: 0~2KV	Current Measure Range: 0A~10A	
8	Discrete Semiconductor Devices -Field effect transistor	3	Gate-source threshold voltage $V_{GS(th)}$	Semiconductor Devices Discrete Devices and Integrated Circuits Part8: Field effect transisitor GB/T 4586-1994 Article 6, Part IV	Current Range: 0~40A	Voltage Measure Range: 0V~2KV	
		4	Small signal short circuit forward transconductance gfs	Semiconductor Devices Discrete Devices and Integrated Circuits Part8: Field effect transisitor GB/T 4586-1994 Article 10, Part IV	Current Range: 0~40A Voltage Range: 0~30V	Measure Range: 0~9999S	

		5	Static source-leakage on-state resistance $r_{DS(on)}$	Semiconductor Devices Discrete Devices and Integrated Circuits Part8: Field effect transistor GB/T 4586-1994 Article 15, Part IV	Current Range: 0~200A Voltage Range: 0~30V	Resistance Measure Range: $1m\Omega \sim 999K\Omega$	
		6	Drain-source breakdown voltage $V_{(BR)DSS}$	Test methods for discrete semiconductor devices Part3 MIL-STD-750-3-2019 Method: 3407.1	Current Range: 0~10mA	Voltage Measure Range: 0V~2KV	
9	AEC-Q100 Reliability Test	1	Preconditioning (PC)	Moisture/Reflow Sensitivity Classification for Nonhermetic Surface Mount Devices JEDEC J-STD-020F-2022 Preconditioning of Nonhermetic Surface Mount Devices Prior to Reliability Testing JEDEC JESD22-A113I-2020	All items	Maximun Volume: HxLxW:1000mm×980mm×800mm; Temperature: $\leq 85^{\circ}\text{C}$; Humidity: 60%RH~95%RH	
		2	Temperature-Humidity-Bias (THB)	Steady-State Temperature-Humidity Bias Life Test JEDEC JESD22-A101D.01-2021	All items	Maximun Volume: HxLxW:1000mm×980mm×800mm; Temperature: $\leq 85^{\circ}\text{C}$; Humidity: 60%RH~95%RH.	
		3	Biased HAST (HAST)	Highly Accelerated Temperature and Humidity Stress Test JEDEC JESD22-A110E.01-2021	All items	Maximun Volume: W×H×D: 355mm×355mm×426mm	
		4	Autoclave (AC)	Accelerated Moisture Resistance-Unbiased Autoclave JEDEC JESD22-A102E-2015	All items	Maximun Volume: W×H×D: 355mm×355mm×426mm	
		5	Unbiased HAST (UHAST)	Accelerated Moisture Resistance-Unbiased HAST JEDEC JESD22-A118B.01-2021	All items	Maximun Volume: W×H×D: 355mm×355mm×426mm	

	6	Temperature-Humidity (without Bias) (TH)	Steady-State Temperature-Humidity Bias Life Test JEDEC JESD22-A101D.01-2021	All items	Maximun Volume: H×L×W:1000mm×980mm×800mm; Temperature: ≤85°C; Humidity: 60%RH~95%RH.	
	7	Temperature Cycling (TC)	Temperature Cycling JEDEC JESD22-A104F-2020	All items	Maximun Volume: H×L×W:410mm×470mm×650mm; Temperature: -68°C~175°C.	
	8	High Temperature Storage Life (HTSL)	High Temperature Stroage Life JEDEC JESD22-A103E.01-2021	All items	Temperature:≤200°C, Maximun Volume: H×L×W:600mm×600mm×600mm	
	9	High Temperature Operating Life (HTOL)	Temperature, Bias, and Operating Life JEDEC JESD22-A108G-2022	All items	Temperature:25°C~150°C	
	10	Early Life Failure Rate (ELFR)	Early Life Failure Rate AEC Q100-008A-2003	All items	Temperature:25°C~150°C	
	11	NVM Endurance, Data Retention, and Operational Life (EDR)	NVM Endurance, Data Retention, and Operational Life AEC Q100-005D1-2012	All items	Temperature:25°C~150°C	
	12	Wire Bond Shear (WBS)	Wire Bond Shear AEC Q100-001C-1998	All items	Shear force≤100kg	
	13	Wire Bond Pull (WBP)	Test Methods for Microelectronic Devices MIL-STD-883L-2019 Method2011.10	Only for Condition D	Pull Force≤100g	
	14	Solderability(SD)	Solderability JESD22-B102E-2007	Only for Immersion and Reflow	TemperatureRange:25°C-350°C	

	15	Physical Dimensions(PD)	Physical Dimensions JEDEC JESD22-B100B-2003	All items	measureRange: ≤400mm Accuracy: 0.0001mm	
	16	Solder Ball Shear(SBS)	Solder Ball Shear AEC Q100-010A-2003	All items	Shear force≤100kg	
	17	Lead Integrity(LI)	Lead Integrity JESD22-B105E-2017	Only for Condition A、B	Pull Force≤4Kg	
	18	Mechanical Shock(MS)	Mechanical Shock-Component and Subassembly JEDEC JESD22-B110B.01-2019	Only for Condition A、 B、 F	Acceleration≤5000g	
	19	Variable Frequency Vibration(VFV)	Variable Frequency Vibration JEDEC JESD22-B103B.01-2016	Only for Condition 1	FrequencyRange: 5HZ~2000HZ Acceleration≤50g	
	20	Constant Acceleration(CA)	Test Methods for Microelectronic Devices MIL-STD-883L-2019 Method 2001	Only for Condition A-EF	Acceleration≤50000 g	
	21	Gross/Fine Leak(GFL)	Test Methods for Microelectronic Devices MIL-STD-883L-2019 Method 1014	Only for Condition H、 C	Fine leak detection: He; Rough leak detection: fluorocarbon	
	22	Die Shear(DS)	Test Methods for Microelectronic Devices MIL-STD-883L-2019 Method 2019	All items	Shear force≤100kg	
	23	Electrostatic Discharge Charged Devices Mode (CDM)	Electrostatic Discharge Charged Devices Mode AEC Q100-011-2019	All items	Voltage Range: 0~2KV	

10	AEC-Q101 Reliability Test	1	Preconditioning (PC)	Moisture/Reflow Sensitivity Classification for Nonhermetic Surface Mount Devices JEDEC J-STD-020F-2022 Preconditioning of Nonhermetic Surface Mount Devices Prior to Reliability Testing JEDEC JESD22-A113I-2020	All items	Temperature: 25°C -150°C; Humidity: 30%RH-98%RH Reflow Temperature: 25°C -300°C	
		2	Biased HAST (HAST)	Highly Accelerated Temperature and Humidity Stress Test JEDEC JESD22-A110E.01-2021	All items	Maximun Volume: W×H×D: 355mm×355mm×42 6mm	
		3	High Humidity, High Temperature Reverse Bias (H ³ TRB)	High Humidity, High Temperature Reverse Bias JEDEC JESD22-A101D.01-2021	All items	Maximun Volume: H×L×W:1000mm×98 0mm×800mm; Temperature: ≤85°C; Humidity: 60%RH~95%RH。	
		4	Unbiased HAST (UHAST)	Accelerated Moisture Resistance-Unbiased HAST JEDEC JESD22-A118B.01-2021	All items	Maximun Volume: W×H×D: 355mm×355mm×42 6mm	
		5	Autoclave (AC)	Accelerated Moisture Resistance-Unbiased Autoclave JEDEC JESD22-A102E-2015	All items	Maximun Volume: W×H×D: 355mm×355mm×42 6mm	
		6	Temperature Cycling (TC)	Temperature Cycling JEDEC JESD22-A104F-2020	All items	Maximun Volume: H×L×W:410mm×470 mm×650mm; Temperature: -68°C~175°C .	

	7	Intermittent Operational Life(IOL)	Test Methods for Discrete Semiconductor Devices MIL-STD-750-1A-2019 Method 1037	All items	Voltage Range: 0~60V Current Range: 0~8A	
	8	High Temperature Reverse Bias (HTRB)	Test Methods for Discrete Semiconductor Devices MIL-STD-750-1A-2019 Method 1038、1039	Only for Condition A	Voltage≤1500V Temperature: 25~175℃	
	9	Steady State Operational (SSOP)	Test Methods for Discrete Semiconductor Devices MIL-STD-750-1A-2019 Method 1038	Only for Condition B	VoltageRange: 0~60V CurrentRange: 0~8A	
	10	High Temperature Gate Bias (HTGB)	Temperature, Bias, and Operating Life JEDEC JESD22-A108G-2022	All items	Voltage≤1500V Temperature: 25~175℃	
	11	Physical Dimensions(PD)	Physical Dimensions JEDEC JESD22-B100B-2003	All items	Size≤400mm Accuracy: 0.0001mm	
	12	Wire Bond Shear Strength (WBS)	Wire Bond Shear Strength AEC Q101-003A-2005 JEDEC JESD22-B116B-2017	All items	Shear force≤100kg	
	13	Wire Bond Pull Strength (WBP)	Test Methods for Discrete Semiconductor Devices MIL-STD-750-2A-2020 Method 2037.1 Qualification Requirements For Components Using Copper (Cu) Wire Interconnections AEC Q006-2015	All items	Pull Force≤100g	
	14	Die Shear (DS)	Test Methods for Discrete Semiconductor Devices MIL-STD-750-2A-2020 Method 2017.3	All items	Shear force≤100kg	
	15	Terminal Strength (TS)	Test Methods for Discrete Semiconductor Devices MIL-STD-750-2A-2020 Method 2036.5	Only for Condition A、E	Pull Force≤4Kg	
	16	Resistance to Solvents (RTS)	Mark Permanency JEDEC JESD22-B107D-2011	Only for ink marking	Mixed solvent1、2、3	

			Evaluation Procedure for Determining Capability to Bottom Side Board Attach by Full Body Solder Immersion of Small Surface Mount Solid State Devices JEDEC JESD22-A111B-2018	Only for Immersion and Reflow	Temperature≤350℃	
		17	Resistance to Solder Heart (RSH)	Resistance to Soldering Temperature for Through-Hole Mounted Devices JEDEC JESD22-B106E-2016	Only for Immersion and Reflow	Temperature≤350℃
	18		Solderability(SD)	Solderability Tests for Component Leads, Terminations, Lugs, Terminals and Wires J-STD-002E-2017	Only for Immersion and Reflow	TemperatureRange2 5°C-350°C
	19		Constant Acceleration(CA)	Test Methods for Discrete Semiconductor Devices MIL-STD-750-2A-2020 Method 2006	Only for Condition A-E	Acceleration≤50000 g
	20		Vibration, Variable Frequency(VVF)	Vibration, Variable Frequency JEDEC JESD22-B103B.01-2016	Only for Condition 1	FrequencyRange: 5HZ~2000HZ Acceleration≤50g
	21		Mechanical Shock(MS)	Mechanical Shock-Component and Subassembly JEDEC JESD22-B110B.01-2019	Only for Condition A、B、F	Acceleration≤50000 g
	22		Hermeticity(HER)	Hermeticity JEDEC JESD22-A109B-2011	Only for Condition H、C	Fine leak detection: He; Rough leak detection: fluorocarbon
	23		External Visual (EV)	External Visual JEDEC JESD22-B101D-2022	All items	Magnification: 7.5~100X
	24		ESD HBM Characterization (ESDC)	ESD HBM Characterization AEC Q101-005-2019	All items	VoltageRange: 0~2KV